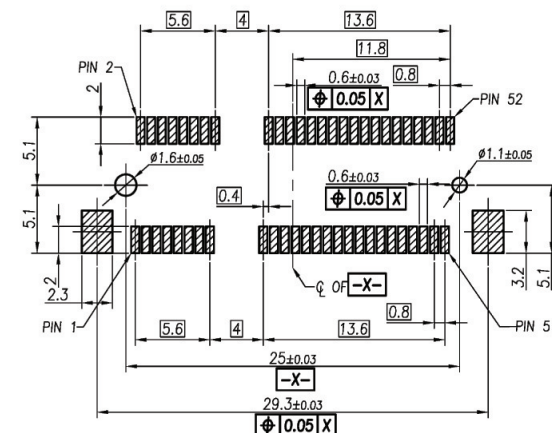
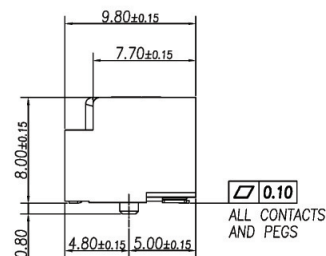
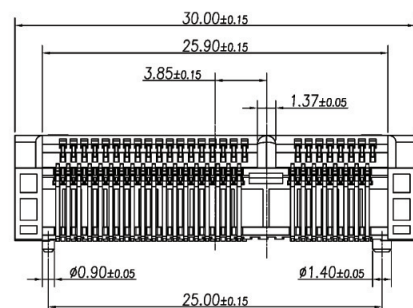
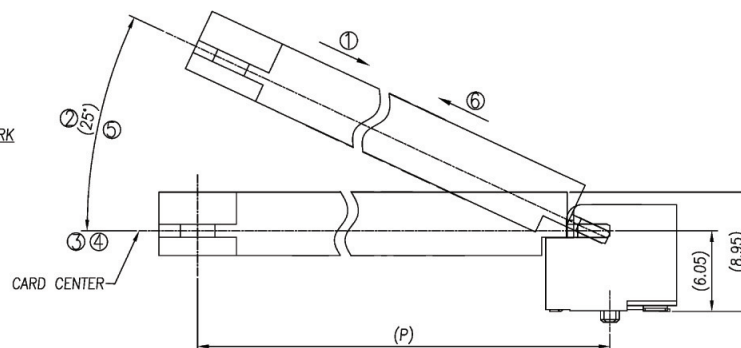
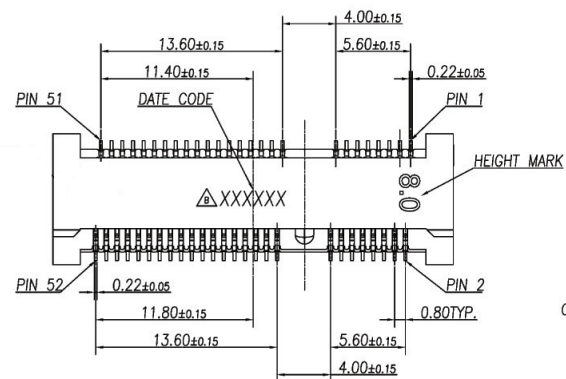




RECOMMEND PCB LAYOUT (MINIMUM THICKNESS OF THE PCB IS 0.8mm)

- NOTES:
- MATERIAL: (OTHER TOLERANCES ARE NOT MARKED: ±0.03)
HOUSING : THERMOPLASTIC , BLACK COLOR ,
FLAME RESISTANCE UL94V-0.
CONTACTS : COPPER ALLOY, THICKNESS 0.20mm.
SOLDER PEGS : COPPER ALLOY, THICKNESS 0.2mm.
 - MSL LEVEL:
MSL(MOISTURE SENSITIVITY LEVELS)=1
 - FINISHED:
CONTACTS : GOLD PLATING ON CONTACT AREA
50u"~120u" MATTE TIN PLATING ON SOLDER AREA.
30u"~120u" NICKEL UNDER PLATING OVER ALL.
SOLDER PEGS : 50u"~120u" MATTE TIN PLATING OVER ALL.
50u"~120u" NICKEL UNDER PLATING OVER ALL.



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TOLERANCE:

X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X.' ±2' X.X' ±0.5'



UNIT: mm [inch]

SCALE:1:1

SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

MINI PCI-E 52P 8.0H

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

HYCW26-PCI52-800B

MOLD NO.

APPROVED BY:

邱敏

DATE :

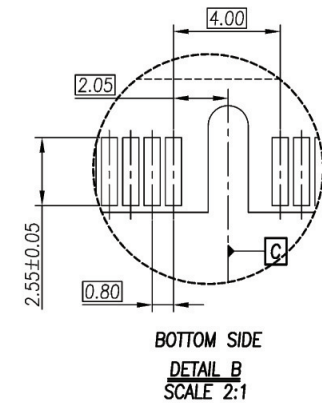
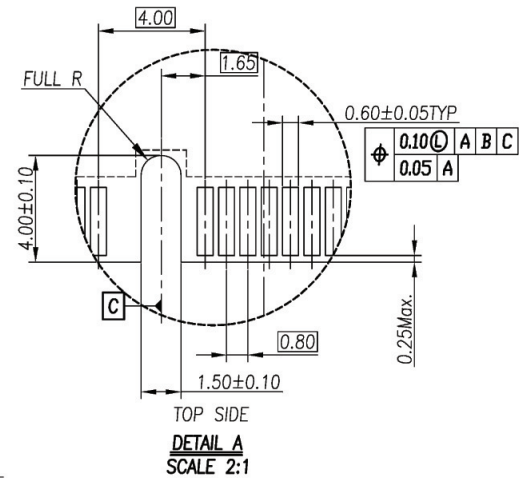
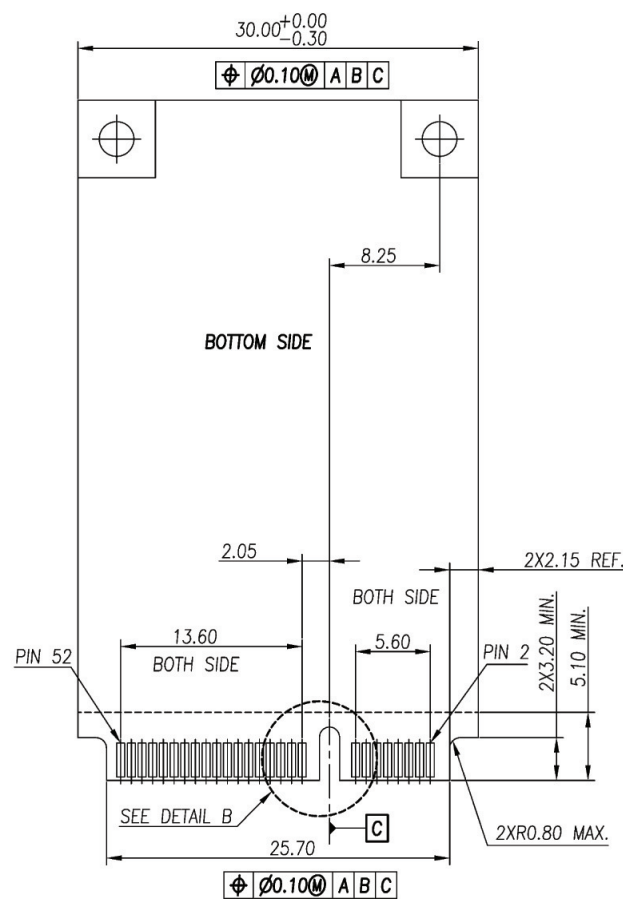
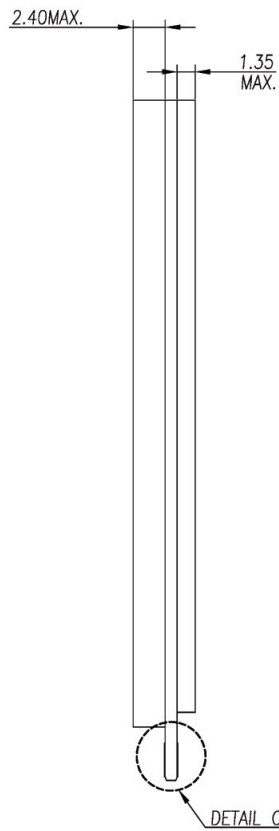
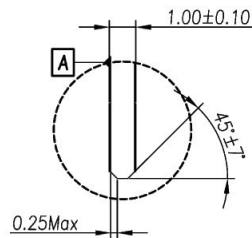
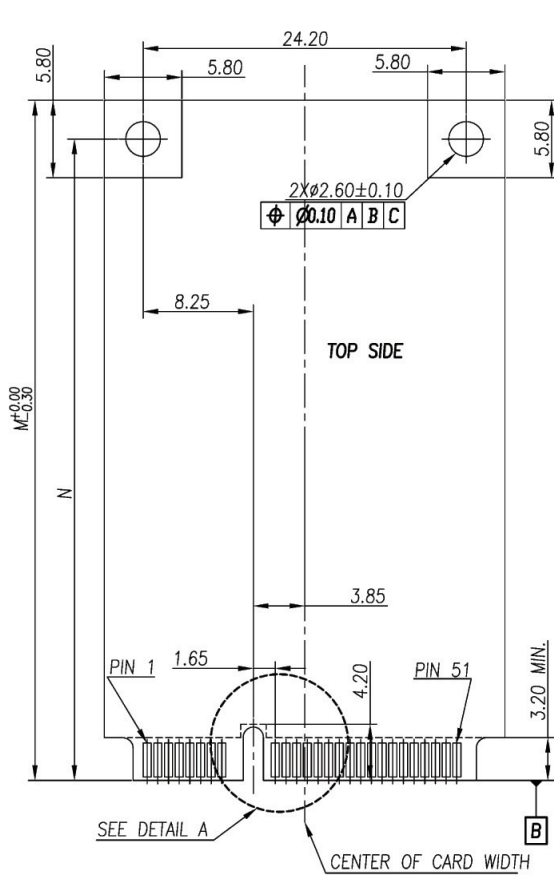
2014-02-23

DRAW NO:

HYC-2308011757

SHEET NO.

1 OF 1



	M	N	P
FULL-MINI CARD	50.95	48.05	48.05
HALF-MINI CARD	26.8	23.9	23.9

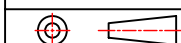


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TOLERANCE:

X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X' ±2° X.X' ±0.5°



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY :

陈一鸣

CHECKED BY:

马跃

APPROVED BY:

邱敏

DATE :

2014-02-23

DATE :

2014-02-23

DATE :

2014-02-23

PART NAME:

MINI PCI-E 52P 8.0H

PART NO.

HYCW26-PCI52-800B

MOLD NO.

HYC-2308011757

SHEET NO.

1 OF 1